



Serial No. 09/893,455

SKI.007D

Amendment dated February 5, 2004

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT APPLICATION of

Hiroyuki Nishi et al.

Group Art Unit: 1732

Serial No.: 09/893,455

Examiner: A. Ortiz

Filed: June 29, 2001

Confirm. No.: 7179

For: TRANSFER MOLDING METHOD FOR MANUFACTURING SEMICONDUCTOR  
DEVICES

### AMENDMENT UNDER 37 C.F.R. 1.116

U.S. Patent and Trademark Office  
2011 South Clark Place  
Customer Window, Mail Stop AF  
Crystal Plaza Two, Lobby, Room 1B03  
Arlington, VA 22202

Date: February 5, 2004

Sir:

In response to the Final Office Action dated November 6, 2003, the following  
amendments and remarks are respectfully submitted in connection with the above-  
identified application.

**Amendments to the Claims** are reflected in the listing of claims which begins  
on page 2 of this paper.

**Remarks/Arguments** begin on page 7 of this paper.